S/N: New Patent Appl.

Atty. Docket No. SA9-99-140US2



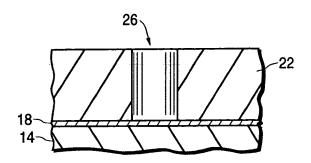


FIG.1 (PRIOR ART)

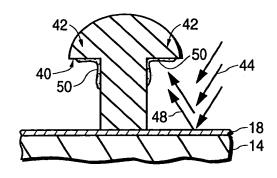


FIG.4 (PRIOR ART)

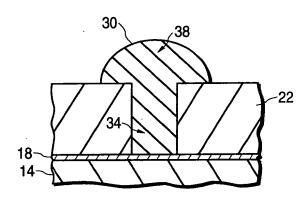


FIG.2 (PRIOR ART)

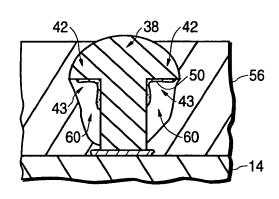


FIG.5 (PRIOR ART)

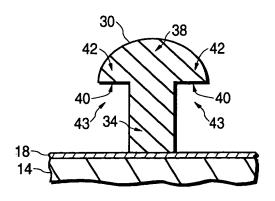


FIG.3 (PRIOR ART)

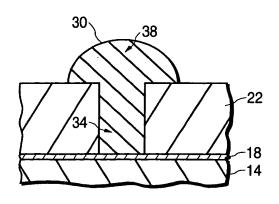
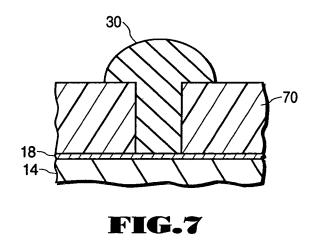
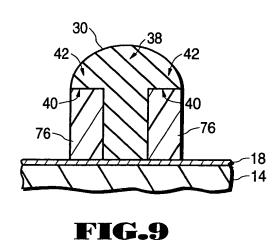
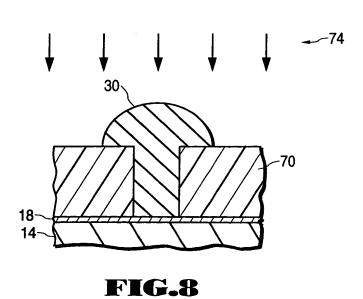
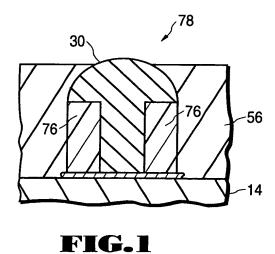


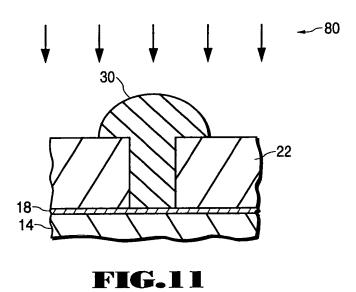
FIG.6 (PRIOR ART)





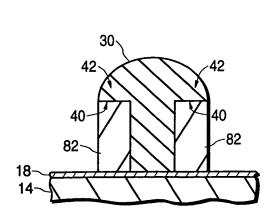






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FIG.13





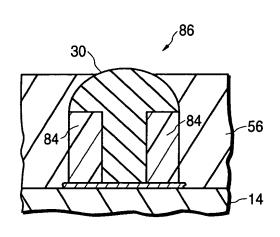


FIG.14

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Plating
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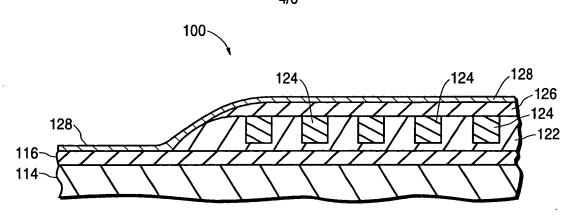


FIG.15 (PRIOR ART)

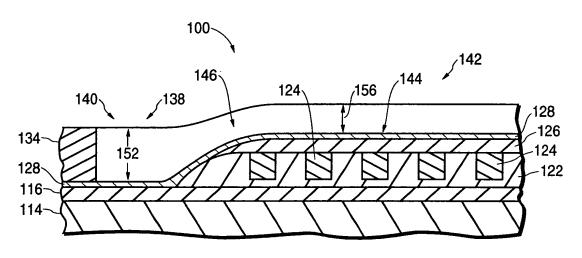


FIG.16 (PRIOR ART)

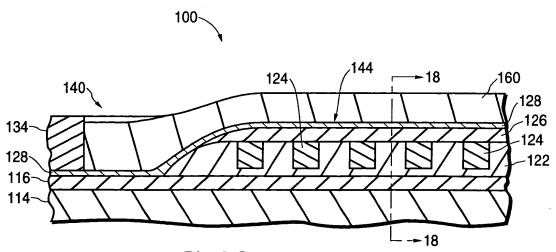


FIG.17 (PRIOR ART)

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Plating
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Atty. Docket No. SA9-99-140US2

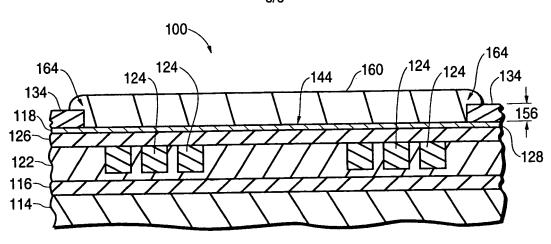


FIG.18 (PRIOR ART)

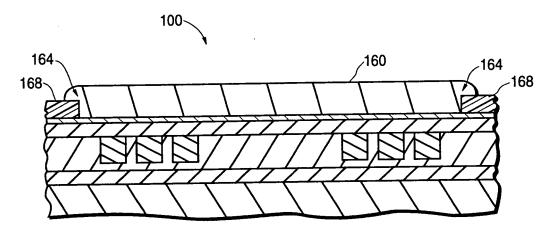


FIG.19

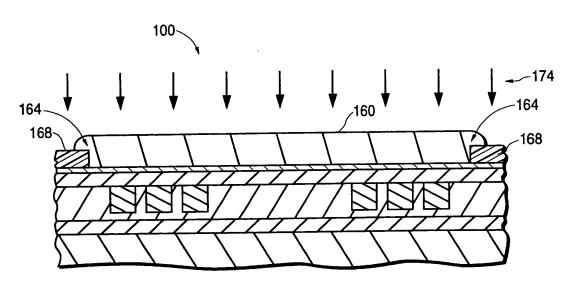


FIG.20

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Self-Aligned Void Filling For Mushroomed
Plating
S/N: New Patent Appl.
Atty. Docket No. SA9-99-140US2

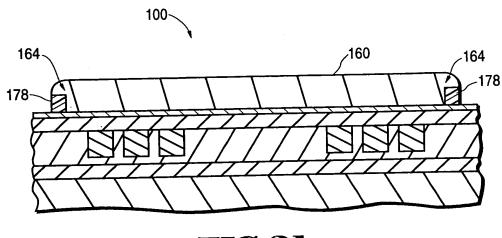


FIG.21

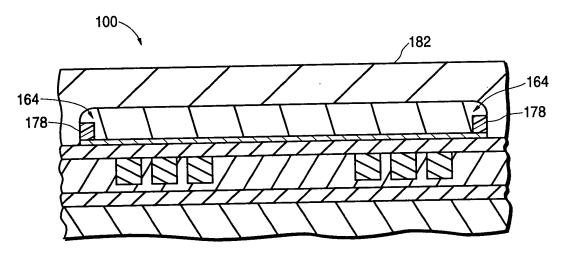


FIG.22

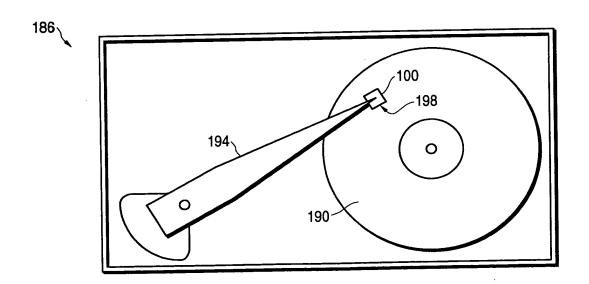


FIG.23